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October 2007

# FSAL200 — Wide Bandwidth Quad 2:1 Analog Multiplexer / De-multiplexer Switch

#### **Features**

- Typical 6Ω Switch Connection Between Two Ports
- Minimal Propagation Delay Through the Switch
- Low I<sub>CC</sub>
- Zero Bounce in Flow-Through Mode
- Control Inputs Compatible with TTL Level
- Rail-to-Rail Signal Handling
- Route Communications Signals Include:
  - 10/100 Ethernet
  - 100VG—AnyLAN
  - ATM25
  - SONET OCI 51.8Mbps
  - USB1.1
  - T1/E1
  - Token Ring 4/16Mbps

## **Description**

The Fairchild Switch FSAL200 is a rail-to-rail quad 2:1 high-speed CMOS TTL-compatible analog multiplexer / de-multiplexer switch. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

When OE is low, the select pin connects the A Port to the selected B Port output. When OE is high, the switch is open and a high-impedance state exists between the two ports.

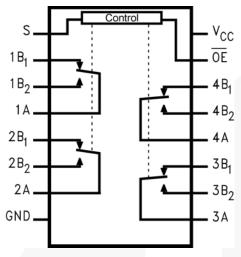
## **Ordering Information**

Part Number	Package Description	
FSAL200MTC	16-Lead Thin Shrink Small Outline Package(TSSOP), JEDEC MO-153, 4.4mm Wide	Rails
FSAL200MTCX	16-Lead Thin Shrink Small Outline Package(TSSOP), JEDEC MO-153, 4.4mm Wide	Tape and Reel
FSAL200QSC	16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide	Rails
FSAL200QSCX	16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150" Wide	Tape and Reel



All packages are Pb-free per JEDEC standard J-SDD-020B.

## **Pin Configurations**



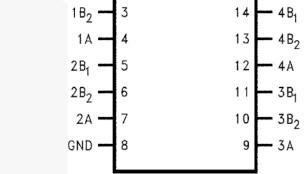


Figure 1. Analog Symbol

Figure 2. Connection Diagram

16

15

ŌĒ

Control Input(s)	ŌĒ	Function
X	High	Disconnected
Low	Low	A=B1
High	Low	A=B2

## **Pin Descriptions**

Pin Names	Function
ŌĒ	Switch Enable
S	Select Input
A, B1, B2	Data Ports

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Max.	Unit
V <sub>CC</sub>	Supply Voltage	-0.5	7.0	V
$V_{SW}$	DC Switch Voltage <sup>(1)</sup>	-0.5	0.5	V
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>	-0.5	7.0	V
I <sub>IK</sub>	DC Input Diode Current at (I <sub>IK</sub> ) V <sub>IN</sub> < 0V		-50	mA
I <sub>OUT</sub>	DC Output Current		120	mA
I <sub>CC</sub> /I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current		±100	mA
P <sub>D</sub>	Power Dissipation at 85°C		0.5	W
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C
T <sub>A</sub>	Ambient Temperature with Power Applied	-40	+85	°C

#### Note:

1. Input and output negative ratings may be exceeded if input and output diode current ratings are observed.

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	Supply Voltage		5.5	V
V <sub>IN</sub>	Control Input Voltage <sup>(2)</sup>	Control Input Voltage <sup>(2)</sup>		V <sub>CC</sub>	V
V <sub>SW</sub>	Switch Input Voltage	Switch Input Voltage		Vcc	V
$V_{OUT}$	Output Voltage	Output Voltage		V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
4 4.	t lanut Dies and Fall Time	Control Input V <sub>CC</sub> =2.3V -3.6V	0	10	ns/V
t <sub>r</sub> ,t <sub>f</sub>	Input Rise and Fall Time Control Input V <sub>CC</sub> =4.5V -5.5V		0	5	115/ V
$\theta_{JA}$	Thermal Resistance in Still Sir				°C/W

#### Note:

2. Control input must be held HIGH or LOW and it must not float.

#### **DC Electrical Characteristics**

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	T <sub>A</sub> =-40	)°C to +	85°C	Units	
				Min.	Тур.	Max.		
VIH	Input Voltage High		4.5 to 5.5	2.0			V	
VIH	input voitage riigii		3.0 to 3.6	2.0			V	
VII	Input Voltage Low		4.5 to 5.5	-0.5		0.8	V	
VIL	input voltage Low		3.0 to 3.6	-0.5		0.8		
$I_{OZ}$	Off State Leakage Current	$0 \leq V_{IN} \! \leq \! 5.5V$	0 to 5.5			100	μA	
Ъ	Switch On Resistance <sup>(3)</sup>	I <sub>ON</sub> =10 -30mA	4.5 to 5.5		6	12	0	
R <sub>ON</sub>	I <sub>ON</sub> =10	I <sub>ON</sub> =10 -30mA	3.0 to 3.6		15	22	Ω	
		V <sub>IN</sub> =V <sub>CC</sub> or GND	5.5	5.5		±1		
I <sub>IN</sub>	Control input Leakage	ontrol Input Leakage V <sub>IN</sub> =V <sub>CC</sub> or GND				±1	μA	
Icc	Quiescent Supply Current, All Channels Off	V <sub>IN</sub> =V <sub>CC</sub> or GND, I <sub>OUT</sub> =0	5.5			1	μΑ	
	Analog Signal Range		Vcc	0		Vcc	V	
$\Delta R_ON$	On Resistance Matching	I <sub>A</sub> =-30 mA, V <sub>BN</sub> =3.15	4.5 to 5.5	1	0.4	2.0	0	
ΔKON	Between Channels (3)(4)	I <sub>A</sub> =-10 mA, V <sub>BN</sub> =2.1	3.0 to 3.6		1.0	3.0	Ω	
	D. D. O. C. V. S. V.	B <sub>n</sub> , B <sub>n</sub> , S-0V to 5V	4.5 to 5.5	100			- A	
I <sub>O</sub>	Output Current	D <sub>n</sub> , D <sub>n</sub> , 3-07 10 37	3.0 to 3.6	80			mA	
D	On Resistance Flatness <sup>(3)(5)</sup>	A <sub>1</sub> , B <sub>1</sub> , B <sub>2</sub> =0V to 5V	4.5 to 5.5		3			
R <sub>FLAT(ON)</sub>	On Resistance Flatiless	A <sub>1</sub> , B <sub>1</sub> , B <sub>2</sub> =0V to 5V	3.0 to 3.6		7		Ω	

#### Notes:

- 3. Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B ports).
- $\Delta R_{ON} = R_{ON}$  maximum  $-R_{ON}$  minimum measured at identical  $V_{CC}$ , temperature, and voltage levels. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

#### **AC Electrical Characteristics**

Typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	Min.	Тур.	Max.	Units	Figure
4	4 T On Time	VB <sub>n</sub> =3V	4.5 to 5.5		10	20	no	Figure 3
t <sub>ON</sub>	Turn-On Time	VB <sub>n</sub> =1.5V	3.0 to 3.6		28	40	ns	Figure 4
4	Turn-Off Time	VB <sub>n</sub> -3V	4.5 to 5.5		5	10	no	Figure 3
t <sub>OFF</sub>	Turn-On Time	VB <sub>n</sub> =1.5V	3.0 to 3.6		4	20	ns	Figure 4
Q	Charge	C <sub>L</sub> =0.1nF,V <sub>GEN</sub> =0	5.0		7		20	Figure 5
Q	Injection	R <sub>GEN</sub> =0Ω	3.3		3		- pC	Figure 5
OIRR	Off loolation	R <sub>L</sub> =100Ω ,f=30MHz	4.5 to 5.5		-55		dB	Figure 6
OIKK	R Off Isolation	R <sub>L</sub> =50Ω, f=1MHz	3.0 to 3.6		-75			Figure 6
Xtalk	Crosstalle	R <sub>L</sub> =100Ω ,f=30MHz	4.5 to 5.5		-70		dB	Figure 7
Alaik	Crosstalk	R <sub>L</sub> =50Ω, f=1MHz	3.0 to 3.6		-75		uБ	Figure 7
DW	BW -3db Bandwidth	R <sub>L</sub> =100Ω	4.5 to 5.5		137		N 41 1-	F: 0
BVV		R <sub>L</sub> =50Ω	3.0 to 3.6		110		MHz	Figure 9
	D 4000	D 4000	4.5 to 5.5		2		%	Figure 0
D	$\Delta R_{ON/RL}$	R <sub>L</sub> =100Ω	3.0 to 3.6	3		% Figure	Figure 9	

#### Notes:

- 6. Guaranteed by design.
- 7. Off Isolation =20  $log_{10} [V_A / V_{Bn}]$ .

## Capacitance

T<sub>A</sub>=+25°C, f=1MHz. Capacitance is characterized, but not tested in production.

Symbol	Parameter	Conditions	Тур.	Units	Figure
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> =0V	2.3	pF	
C:	B Port Off Capacitance	V <sub>CC</sub> =5.0V and 3.0V	8	nE	Figure 10
CIO-B	C <sub>IO-B</sub> A Port Off Capacitance		13	pF	Figure 10
Con	Channel On Capacitance	V <sub>CC</sub> =5.0V and 3.0V	15	pF	Figure 7

## **AC Loadings and Waveforms**

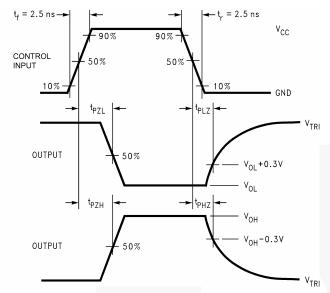


Figure 3. AC Waveforms

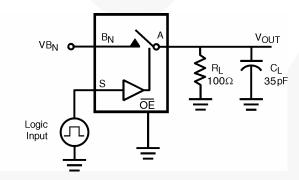
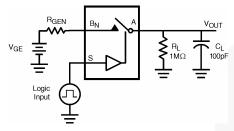


Figure 4. ton, toff Loading

## AC Loadings and Waveforms (Continued)



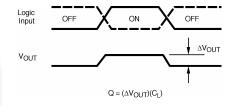


Figure 5. Charge Injection Test

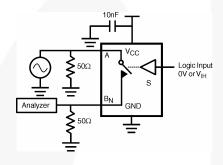


Figure 6. Off Isolation

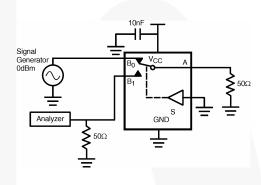
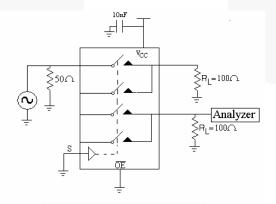


Figure 7. Channel On Capacitance



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Figure 8. Crosstalk

Figure 9. Bandwidth

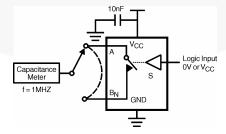


Figure 10. Channel Off Capacitance

## **Physical Dimensions**

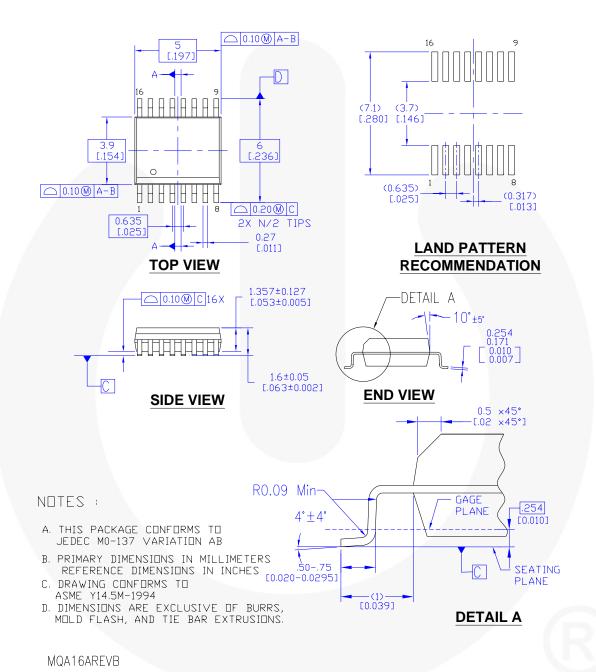


Figure 11. 16-lead, Quarter Size Outline Package (QSOP), JEDEC MO-137. 0.150" wide Click here for tape and reel specifications, available at:

http://www.fairchildsemi.com/products/analog/pdf/qsop16\_tr.pdf

#### Physical Dimensions (Continued) A 5.00±0.10 4.55 5.90 4.45 7.35 В 0.65 6.4 4.4±0.1 1.45 3.2 O.2 CBA ALL LEAD TIPS 5.00 PIN #1 IDENT. LAND PATTERN RECOMMENDATION (F) 0.11 -SEE DETAIL A ALL LEAD TIPS 1.1 MAX (0.90)□ 0.1 C 0.09-0.20 -C-0.10±0.05 0.65 0.19 - 0.30 TOP AND BOTTOM ⊕ 0.10M A BS CS GAGE PLANE NOTES: 0.25 0°-8° A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, B. DIMENSIONS ARE IN MILLIMETERS C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS -0.6±0.1 SEATING PLANE D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1994 E. DRAWING FILE NAME: MTC16REV4 **DETAIL** A

Figure 12. 16-lead, Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm wide

Click here for tape and reel specifications, available at:

http://www.fairchildsemi.com/products/analog/pdf/tssop16\_tr.pdf

F. LAND PATTERN RECOMMENDATION PER IPC7351 - ID#

TSOP65P640X110-16N

MTC16rev4





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